LNJ121W84RA

Surface Mounting Chip LED

Dome-Lens 2 Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

• `	Yellow	Green
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Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	60	mW	
Forward current	I _F	20	mA	
Pulse forward current	I _{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

 Yellow Green • Red

• Red

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	55	mW	
Forward current	I _F	20	mA	
Pulse forward current	I _{FP}	60	mA	
Reverse voltage	VR	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Electro-Optical Characteristics T_a = 25°C

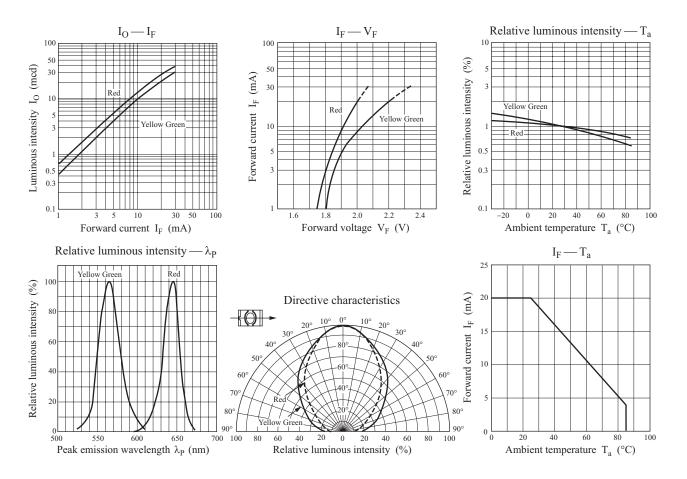
• Yellow Green

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	Io	$I_{\rm F} = 10 \mathrm{mA}$	5.0	10		mcd
Reverse current	I _R	$V_R = 4 V$			10	μΑ
Forward voltage	V _F	$I_{\rm F} = 10 \mathrm{mA}$		2.03	2.6	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 10 \text{ mA}$		565		nm
Spectral half band width	Δλ	$I_{\rm F} = 10 {\rm mA}$		30		nm

• Red		e ²⁵⁰				
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_{\rm F} = 10 {\rm mA}$	7.0	13.4		mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		1.92	2.5	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 10 \text{ mA}$		645		nm
Spectral half band width	Δλ	$I_{\rm F} = 10 {\rm mA}$		22		nm

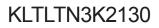
LNJ121W84RA

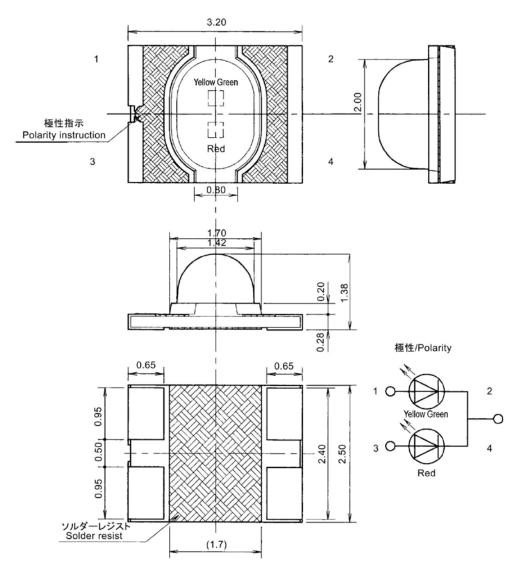
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Package (Unit: mm)





• Pin name

1, 3: Anode

2, 4: Cathode

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